

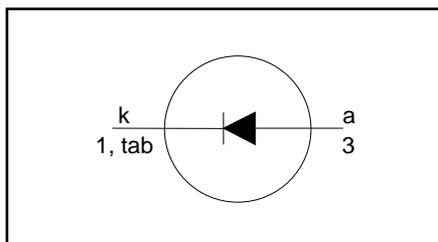
**Rectifier diodes
Schottky barrier**

**PBYL2520CT, PBYL2520CTB
PBYL2525CT, PBYL2525CTB**

FEATURES

- Low forward voltage drop
- Repetitive ruggedness rated
- Very high efficiency
- Extremely fast switching
- Guaranteed reliability
- 150°C forward operation

SYMBOL



QUICK REFERENCE DATA

$V_{RRM} = 20, 25 \text{ V}$
$V_F \leq 0.43 \text{ V}$
$I_{O(AV)} = 25 \text{ A}$

GENERAL DESCRIPTION

Nickel silicide schottky barrier rectifier diodes in a plastic envelope. The devices are intended for use in switched mode power supplies, high frequency DC - DC converters or as or-ing diodes in fault tolerant power supply systems.

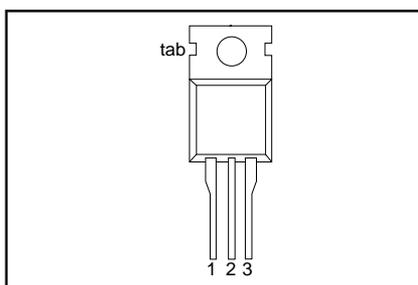
The PBYL2525CT series is supplied in the SOT78 (TO220AB) conventional leaded package.

The PBYL2525CTB series is supplied in the SOT404 surface mounting package.

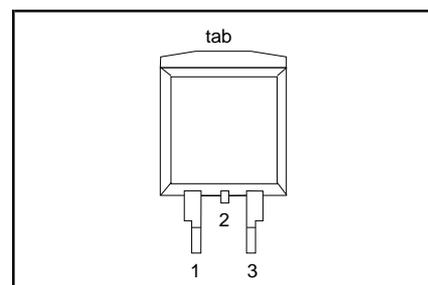
PINNING

PIN	DESCRIPTION
1	anode 1 (a)
2	cathode (k)
3	anode 2 (a)
tab	cathode (k)

SOT78 (TO220AB)



SOT404



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

PARAMETER	CONDITIONS	SYMBOL	MIN.	MAX.		UNIT
Repetitive peak reverse voltage		V_{RRM}	-	-20 20	-25 25	V
Continuous reverse voltage	$T_{mb} \leq 126 \text{ }^\circ\text{C}$	V_R	-	20	25	V
Average forward current	square wave; $\delta = 0.5$; $T_{mb} \leq 122 \text{ }^\circ\text{C}$	$I_{O(AV)}$	-	25		A
RMS forward current		$I_{O(RMS)}$	-	35		A
Repetitive peak forward current	$t = 25 \text{ } \mu\text{s}$; $\delta = 0.5$; $T_{mb} \leq 122 \text{ }^\circ\text{C}$	I_{FRM}	-	25		A
Non-repetitive peak forward current	$t = 10 \text{ ms}$ $t = 8.3 \text{ ms}$ sinusoidal $T_j = 125 \text{ }^\circ\text{C}$ prior to surge; with reapplied $V_{RRM(max)}$	I_{FSM}	-	135		A
			-	150		A
Repetitive peak reverse current	$t_p = 2 \text{ } \mu\text{s}$; $\delta = 0.001$	I_{RRM}	-	1		A
Storage temperature		T_{stg}	-65	175		$^\circ\text{C}$
Operating junction temperature		T_j	-	150		$^\circ\text{C}$

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THERMAL RESISTANCES

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Thermal resistance junction to mounting base	per diode both diodes	$R_{th\ j-mb}$	-	-	2.25	K/W
			-	-	1.75	K/W
Thermal resistance junction to ambient	in free air	$R_{th\ j-a}$	-	60	-	K/W

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise stated

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 12.5\text{ A}; T_j = 150\text{ °C}$ $I_F = 25\text{ A}; T_j = 150\text{ °C}$ $I_F = 25\text{ A}$	V_F	-	0.37	0.43	V
			-	0.54	0.64	V
			-	0.59	0.67	V
Reverse current	$V_R = V_{RRM}$ $V_R = V_{RRM}; T_j = 100\text{ °C}$	I_R	-	1.0	10.0	mA
			-	20	30	mA
Junction capacitance	$f = 1\text{ MHz}; V_R = 5\text{ V}; T_j = 25\text{ °C}$ to 125 °C	C_d	-	600	-	pF
Internal cathode inductance	Measured from tab to centre of die	L_k	-	3.5	-	nH
Internal cathode inductance	Measured from cathode lead solder point to centre of die	L_k	-	4.5	-	nH
Internal anode inductance	Measured from anode lead solder point to centre of die	L_a	-	7.5	-	nH

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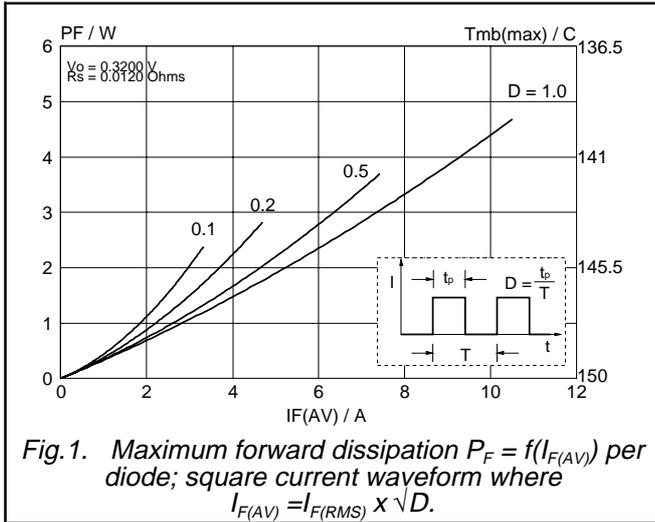


Fig.1. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

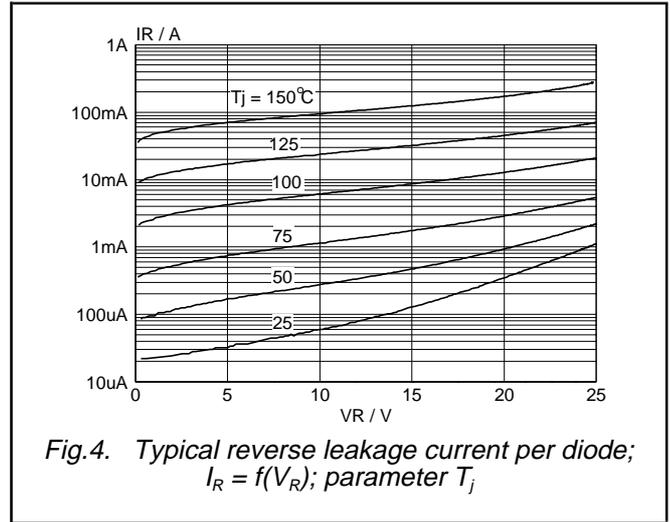


Fig.4. Typical reverse leakage current per diode; $I_R = f(V_R)$; parameter T_j

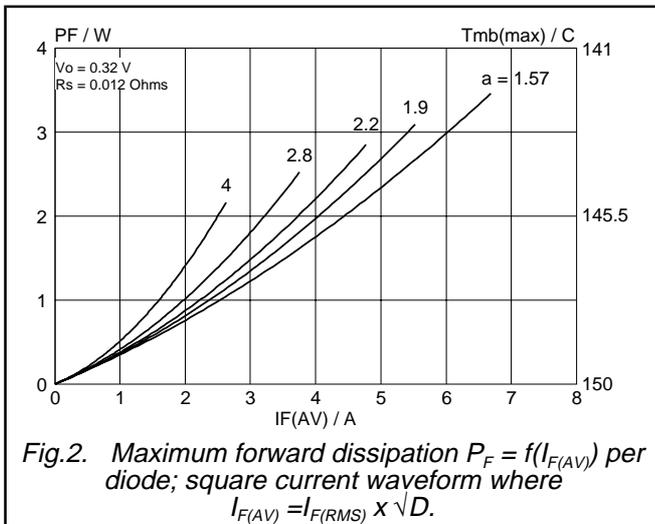


Fig.2. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

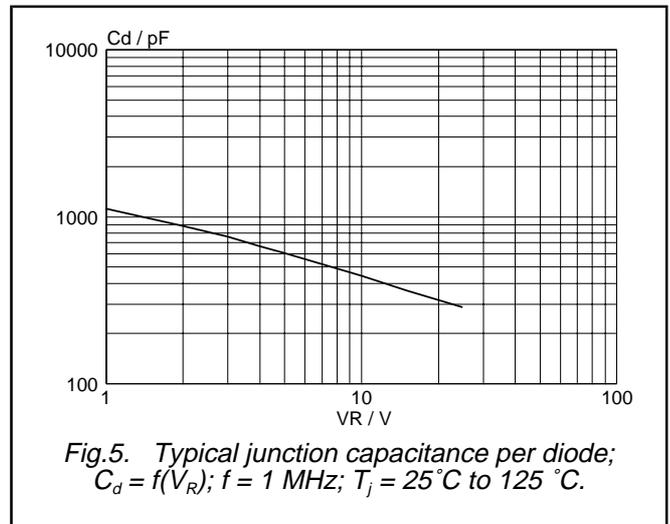


Fig.5. Typical junction capacitance per diode; $C_d = f(V_R)$; $f = 1$ MHz; $T_j = 25$ °C to 125 °C.

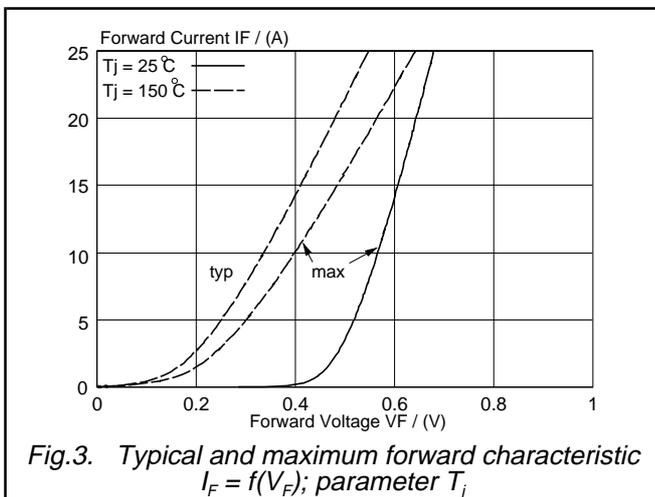


Fig.3. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

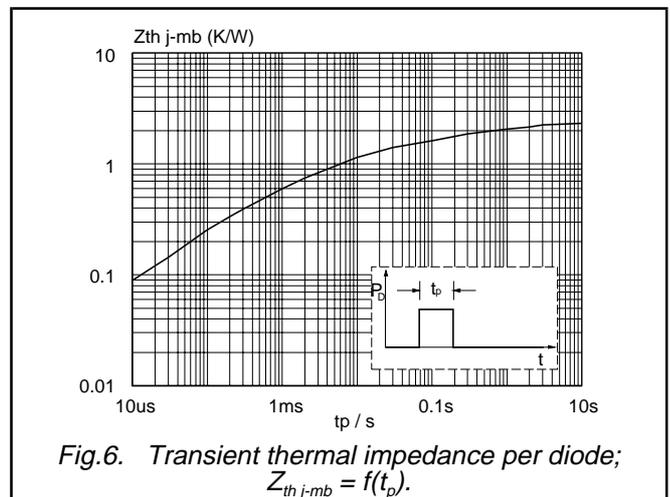
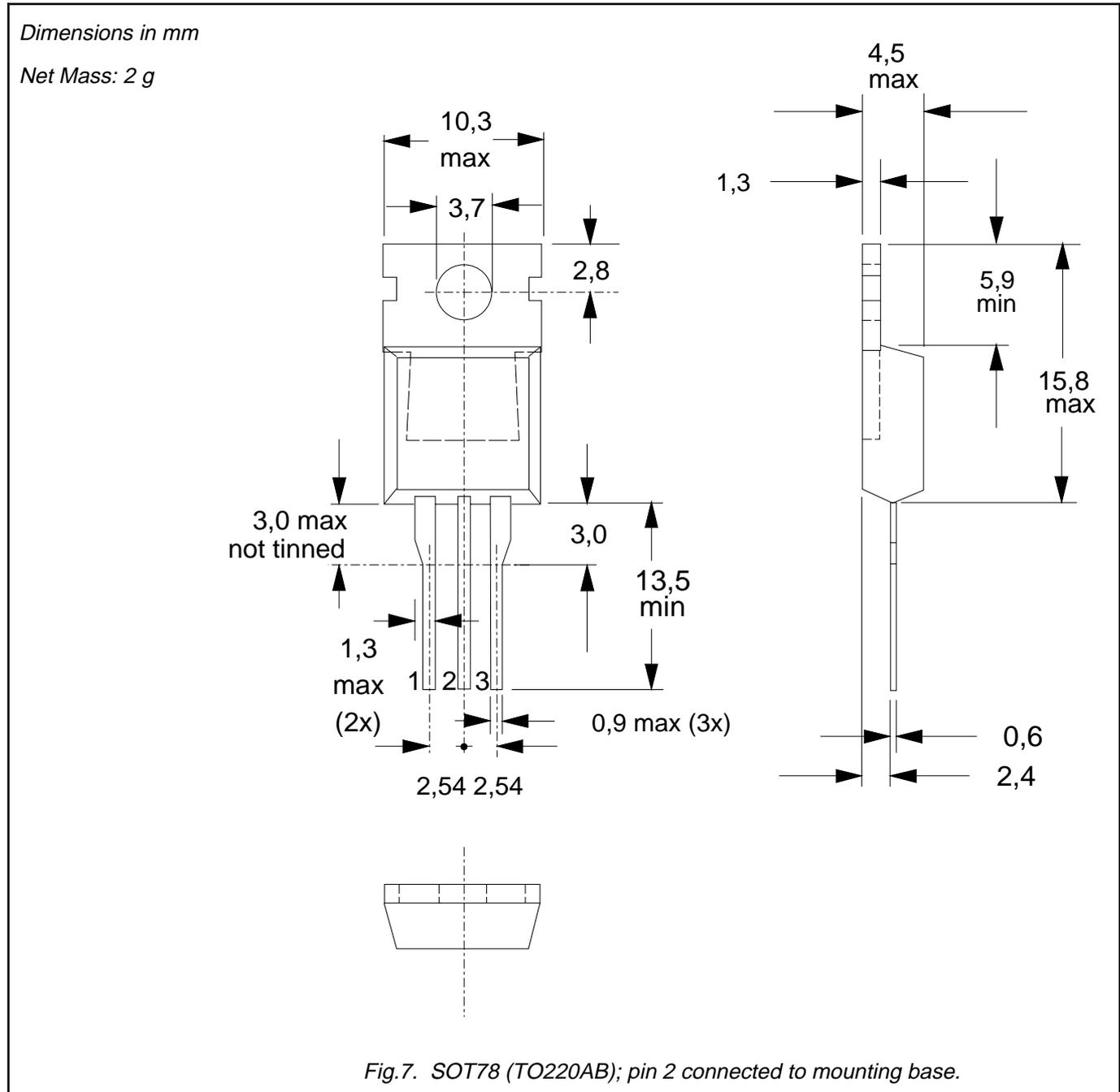


Fig.6. Transient thermal impedance per diode; $Z_{th j-mb} = f(t_p)$.

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MECHANICAL DATA



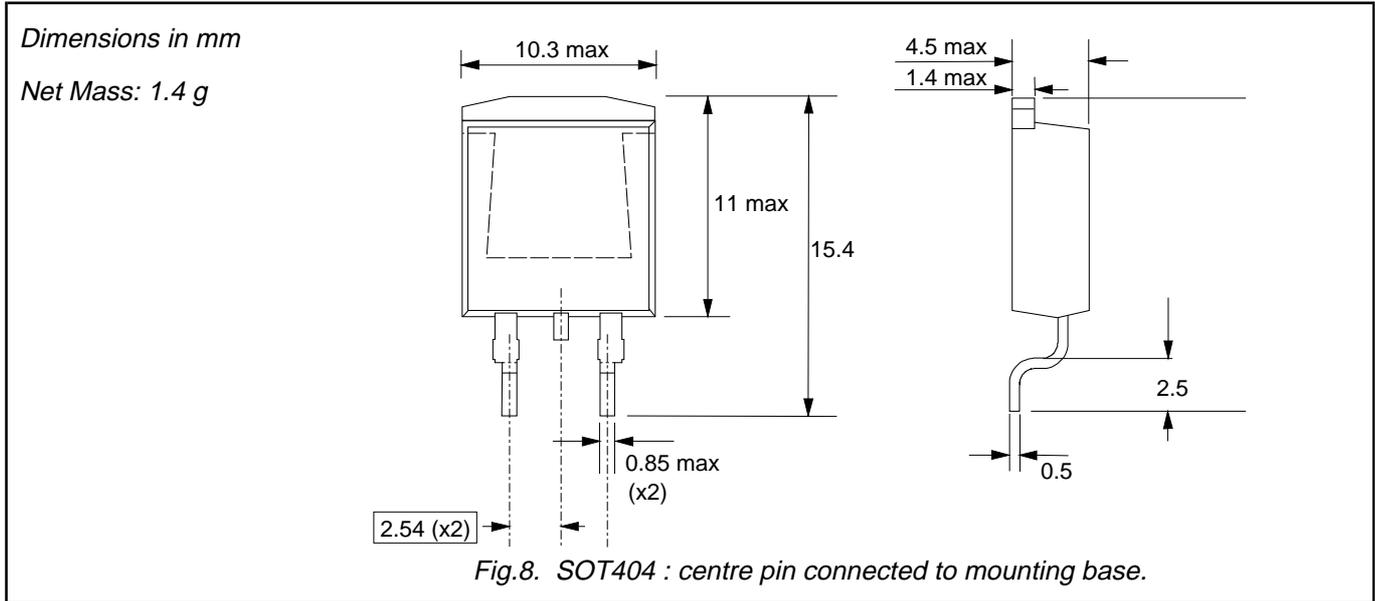
Notes

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Refer to mounting instructions for SOT78 (TO220) envelopes.
3. Epoxy meets UL94 V0 at 1/8".

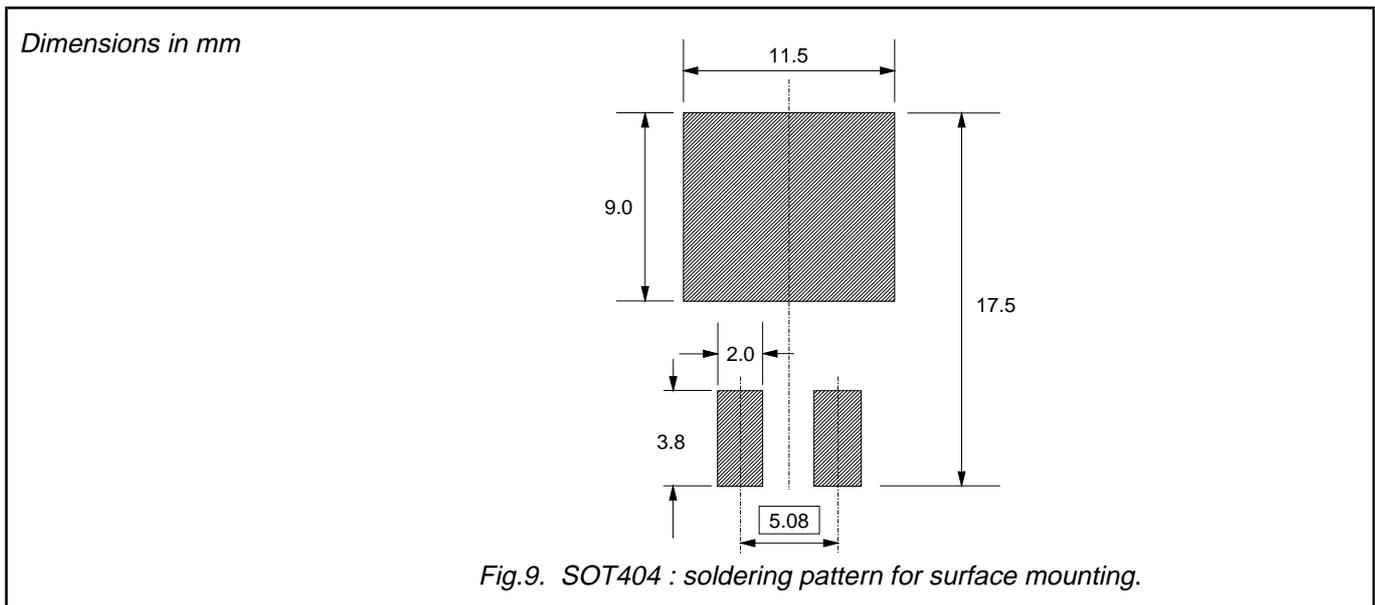
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MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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